

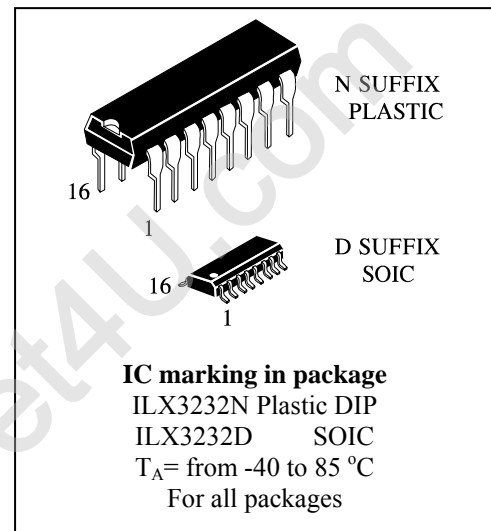
# Interface transceiver of RS-232 standard with one supply voltage

**ILX3232**

IC ILX3232 is purposed for application in high-performance information processing systems and control devices of wide application.

Input voltage levels are compatible with standard CMOS levels.

- Output voltage levels are compatible with input levels of K-MOS, N-MOS and TTL integrated circuits.
- Supply voltage : 3.3V
- Low input current: 1.0  $\mu\text{A}$ ; 0.1  $\mu\text{A}$  at  $T = 25\text{ }^\circ\text{C}$ .
- Output current 24 mA.
- Latching current not less than 450 mA at  $T = 25\text{ }^\circ\text{C}$
- Tolerable value of static potential not less than 2000V

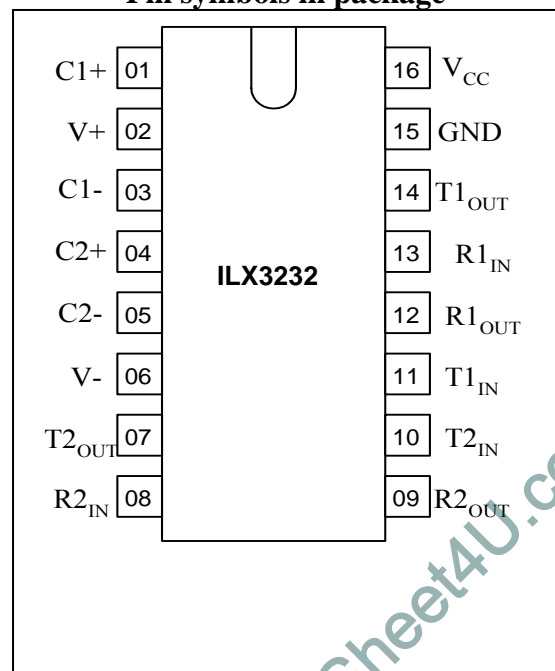


### Truth table

Inputs	Outputs
$R_{IN}, T_{IN}$	$R_{OVT}, T_{OVT}$
H	L
L	H

Note -  
 H – voltage high level;  
 L – low voltage level

### Pin symbols in package



**Table of pin description**

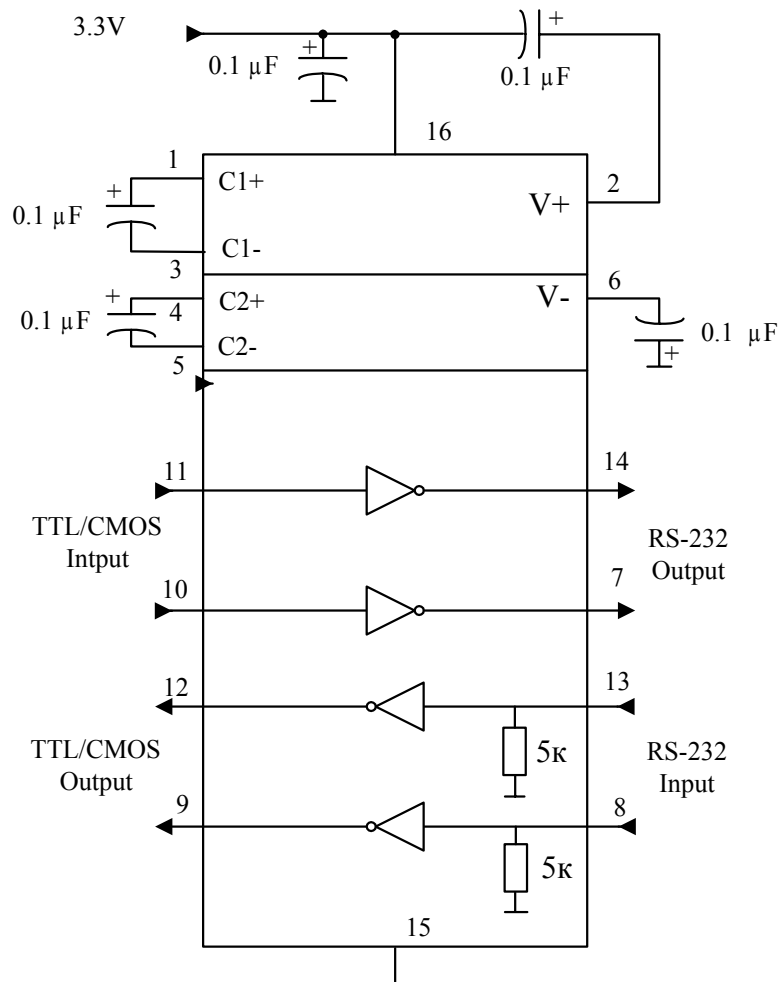
Pin No.	Symbol	Pin name
01	C1+	Output of external capacitance of positive voltage multiplier unit
02	V+	Output of positive voltage of multiplier unit
03	C1-	Output of external capacitance of positive voltage multiplier unit
04	C2+	Output of external capacitance of negative voltage multiplier unit
05	C2-	Output of external capacitance of negative voltage multiplier unit
06	V-	Output of negative voltage of multiplier unit
07	T2 <sub>OUT</sub>	Output of transmitter data (levels RS – 232)
08	R2 <sub>IN</sub>	Input of receiver data (levels RS – 232)
09	R2 <sub>OUT</sub>	Output of receiver data (levels TTL/KMOS)
10	T2 <sub>IN</sub>	Input of transmitter data (levels TTL/KMOS)
11	T1 <sub>IN</sub>	Input of transmitter data (levels TTL/KMOS)
12	R1 <sub>OUT</sub>	Output of receiver data (levels TTL/KMOS)
13	R1 <sub>IN</sub>	Input of receiver data (levels RS – 232)
14	T1 <sub>OUT</sub>	Output of transmitter data (levels RS – 232)
15	GND	Common output
16	V <sub>CC</sub>	Supply output of voltage source

**Maximum conditions**

Symbol	Parameter	Rate		Unit
		min	max	
V <sub>CC</sub>	Supply voltage	-0.3	6.0	V
V+	Transmitter high output voltage	V <sub>CC</sub> - 0.3	14	
V-	Transmitter low output voltage	-0.3	-14	
V <sub>TIN</sub>	Transmitter input voltage	-0.3	V+ + 0.3	
V <sub>RIN</sub>	Receiver input voltage	-30	30	
P <sub>D</sub>	Dissipated power	-	842	mW
	DIP – package SO - package		762	
I <sub>SC</sub>	Output current of transmitter short circuit	-	Continuously	mA
T <sub>a</sub>	Ambient temperature	-60	150	°C

**Recommended Operating Conditions**

Symbol	Parameter	Rate		Unit
		min	max	
V <sub>CC</sub>	Supply voltage	3.0	5.5	V
V <sub>+</sub>	Transmitter output high voltage	V <sub>CC</sub>	-	
V <sub>-</sub>	Transmitter output low voltage	-V <sub>CC</sub>	-	
V <sub>TIN</sub>	Transmitter input voltage	0	V <sub>CC</sub>	
V <sub>RIN</sub>	Receiver input voltage	-30	30	
I <sub>SC</sub>	Transmitter short circuit output current	-	±60	mA
T <sub>a</sub>	Ambient temperature	-40	85	°C



**Static parameters**

Symbol	Parameter	Test conditions	Rate				Unit
			25°C		-40 °C to 85 °C		
			min	max	min	max	
I <sub>CC</sub>	Consumption current static	V <sub>CC</sub> = 3.3 V V <sub>IL</sub> = 0 V	-	10.0	-	14.0*	mA

**Receiver electrical parameters**

V <sub>h</sub>	Hysteresis voltage	V <sub>CC</sub> = 3.3 V	0.2	0.9	0.2	1.0	V
V <sub>On</sub>	On (operation) voltage	V <sub>O</sub> ≤ 0.1 V I <sub>OL</sub> ≤ 20 μA	-	2.4	-	2.3	
V <sub>off</sub>	Off (dropout) voltage	V <sub>O</sub> ≥ V <sub>CC</sub> - 0.1 V I <sub>OH</sub> ≤ -20 μA	0.6	-	0.7	-	
V <sub>OL</sub>	Output low voltage	I <sub>OL</sub> = 3.2 mA V <sub>CC</sub> = 3.0 V V <sub>IH</sub> = 2.4 V	-	0.3	-	0.4	
V <sub>OH</sub>	Output high voltage	I <sub>OH</sub> = -1.0 mA V <sub>CC</sub> = 3.0 V V <sub>IL</sub> = 0.8 V	2.4	-	2.3	-	
R <sub>I</sub>	Input resistance	V <sub>CC</sub> = 3.3 V	3.0	7.0	3.0	7.0	kOhm

**Transmitter electrical parameters**

V <sub>OL</sub>	Output low voltage	V <sub>CC</sub> = 3.0 V V <sub>IH</sub> = 2.0 V R <sub>L</sub> = 3.0 kOhm	-	-3.5	-	-3.3	V
V <sub>OH</sub>	Output high voltage	V <sub>CC</sub> = 3.0 V V <sub>IL</sub> = 0.8 V R <sub>L</sub> = 3.0 kOhm	3.5	-	3.3	-	
I <sub>IL</sub>	Input low current	V <sub>CC</sub> = 3.3 V V <sub>IL</sub> = 0 V	-	-1.0	-	-10.0	μA
I <sub>IH</sub>	Input high current	V <sub>CC</sub> = 3.3 V V <sub>IH</sub> = V <sub>CC</sub>		1.0		10.0	
SR	Speed of output front change	V <sub>CC</sub> = 3.3 V C <sub>L</sub> = 50 - 1000 pF R <sub>L</sub> = 3.0 - 7.0 kOhm	3.0	30	2.7	27	V/μs
R <sub>O</sub>	Output resistance	V <sub>CC</sub> = V <sub>+</sub> = V <sub>-</sub> = 0 V V <sub>O</sub> = ± 2 V	350	-	300	-	Ohm
I <sub>SC</sub>	Short circuit output current	V <sub>CC</sub> = 3.3 V V <sub>O</sub> = 0 V V <sub>I</sub> = V <sub>CC</sub> V <sub>I</sub> = 0 V		-50 50		-60 60	mA
ST	Speed of information transmission	V <sub>CC</sub> = 3.0 V C <sub>L</sub> = 1000 pF R <sub>L</sub> = 3.0 kOhm t <sub>w</sub> = 7 μs (for extreme -t <sub>w</sub> = 8mks)	140	-	120	-	

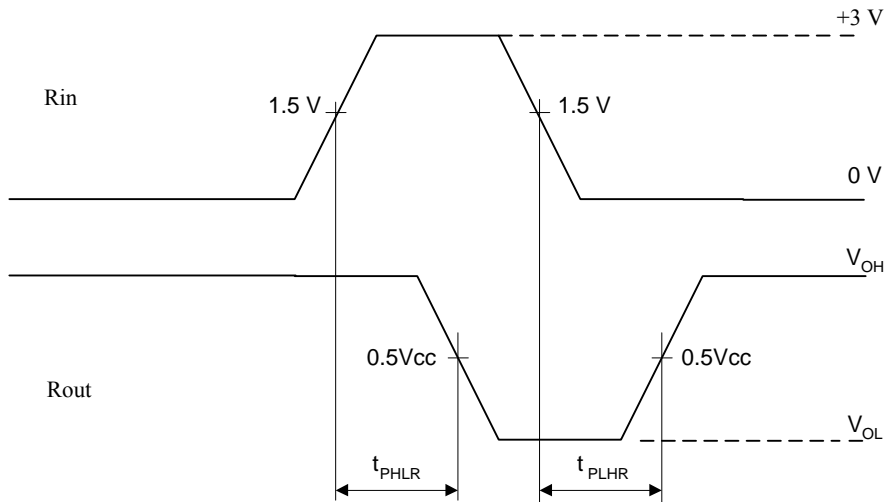
**Dynamic parameters**

Symbol	Parameter	Test conditions	Rate				Unit
			25 °C		from -40 °C to 85 °C		
			min	max	min	max	
$t_{PHLR}$ ( $t_{PLHR}$ )	Signal propagation delay time when switching on (off)	$V_{CC} = 3.0\text{ V}$ $C_L = 150\text{ pF}$ $V_{IL} = 0\text{ V}$ $V_{IH} = 3.0\text{ V}$ $t_{LH} = t_{HL} \leq 10\text{ ns}$	-	9.7	-	10	$\mu\text{s}$
$t_{PHLT}$ ( $t_{PLHT}$ )	Signal propagation delay time when switching on (off)	$V_{CC} = 3.0\text{ V}$ $C_L = 2500\text{ pF}$ $V_{IL} = 0\text{ V}$ $V_{IH} = 3.0\text{ V}$ $R_L = 3\text{ k}\Omega$ $t_{LH} = t_{HL} \leq 10\text{ ns}$		5.0*		6.0*	

**Capacitance**

Symbol	Parameter	$V_{CC}$	Rate	Unit
$C_{IN}$	Input capacitance	3.3	9.0	pF
$C_{PD}$	Dynamic capacitance		90	

Timing diagram when measuring IC dynamic parameters



**Figure 3**

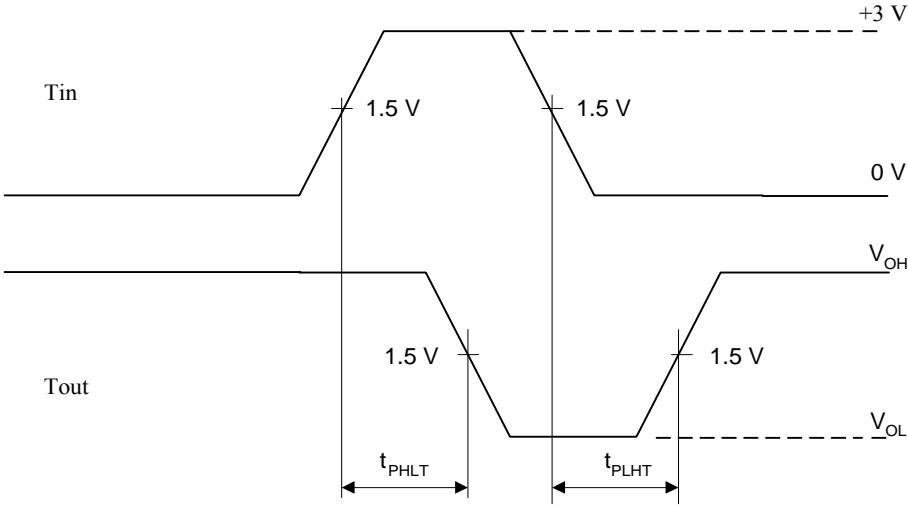


Figure 4

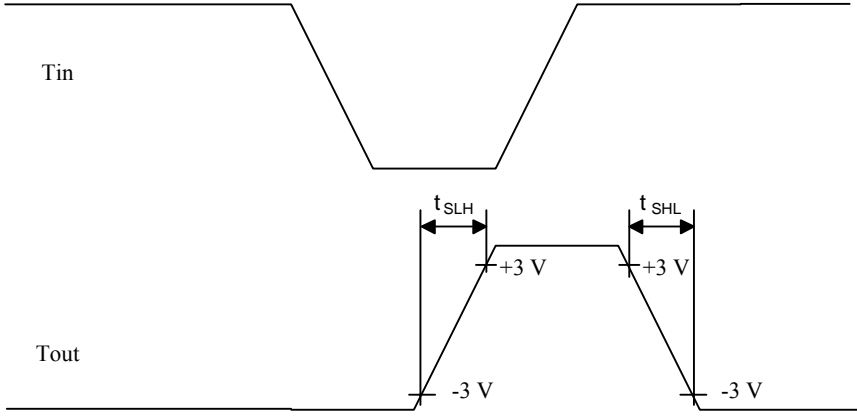


Figure 5

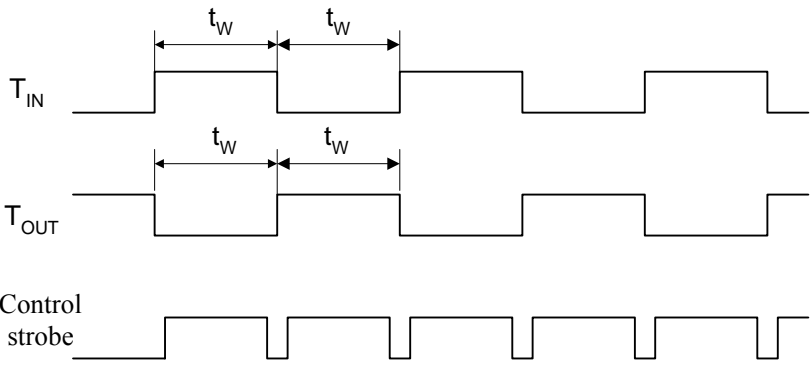


Figure 6

TYPICAL PERFORMANCE CHARACTERISTICS (unless otherwise specified  $T_j = 25^\circ\text{C}$ )

Figure 1 : Driver Voltage Transfer Characteristics for Transmitter Inputs

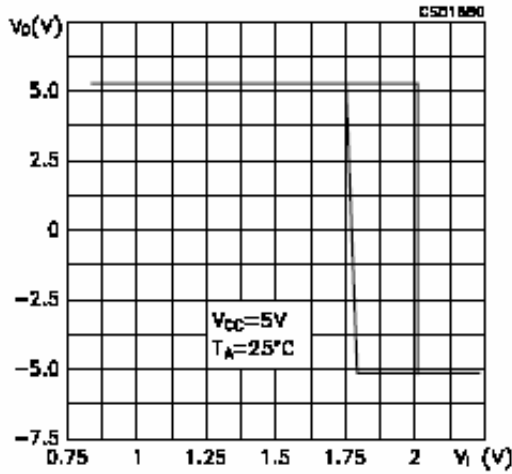


Figure 4 : Output Current vs Output Low Voltage

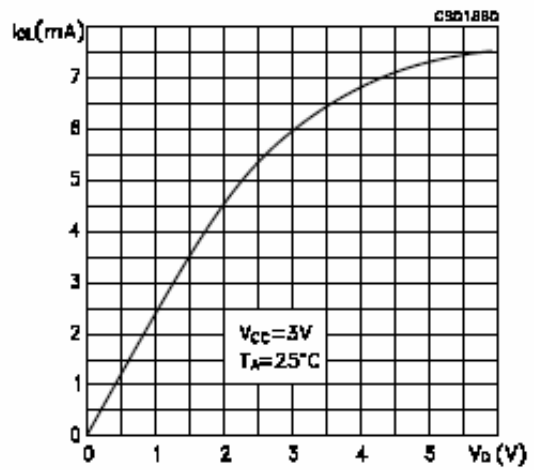


Figure 2 : Driver Voltage Transfer Characteristics for Receiver Inputs

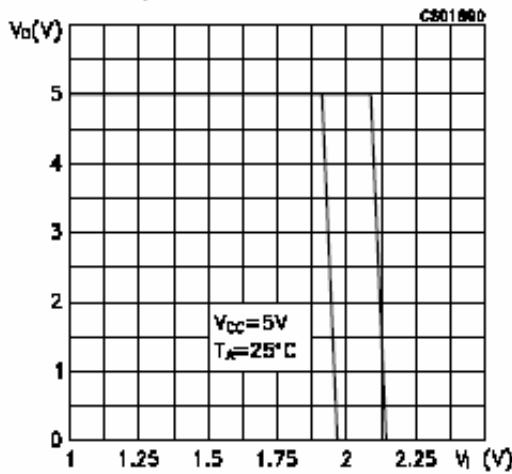


Figure 5 : Output Current vs Output High Voltage

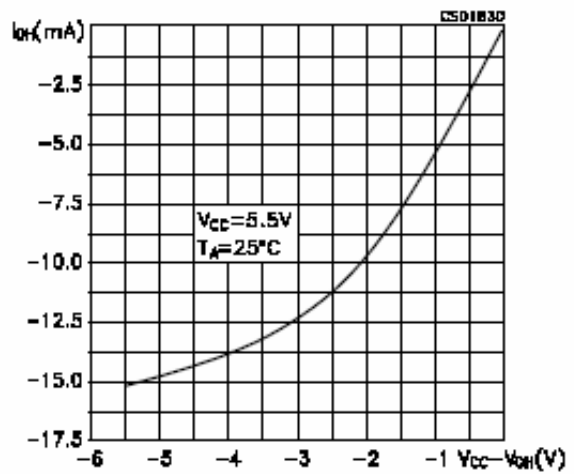


Figure 3 : Output Current vs Output Low Voltage

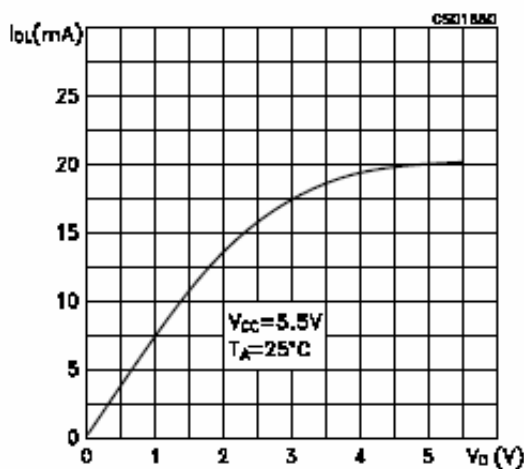


Figure 6 : Output Current vs Output High Voltage

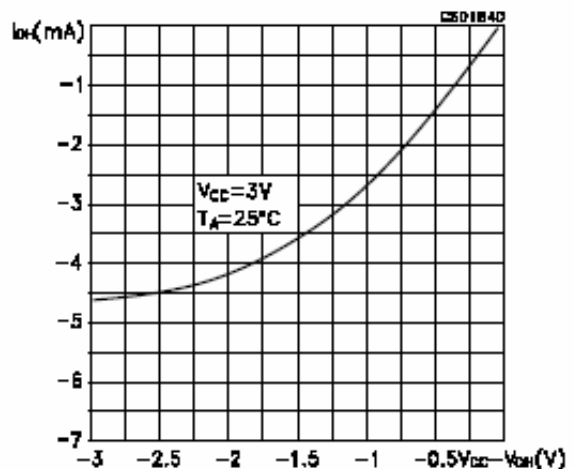
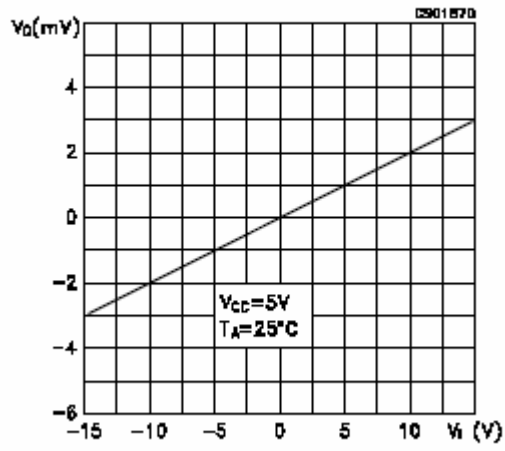
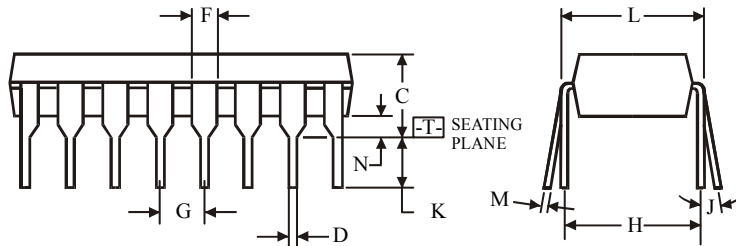
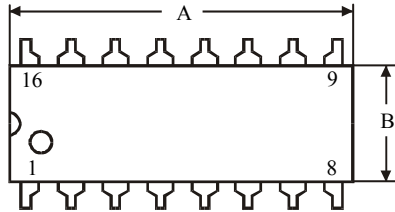
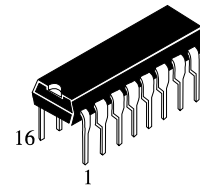


Figure 7 : Receiver Input Resistance





**N SUFFIX PLASTIC DIP  
(MS - 001BB)**



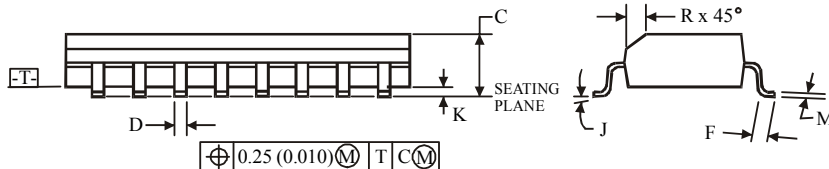
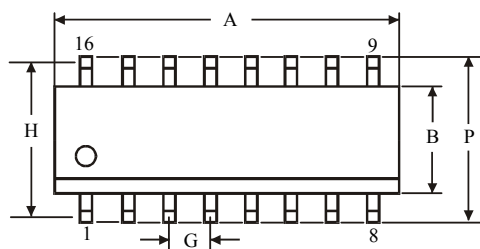
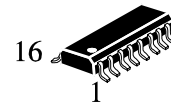
$\oplus 0.25 (0.010) \text{ (M) T}$

**NOTES:**

- Dimensions "A", "B" do not include mold flash or protrusions.  
Maximum mold flash or protrusions 0.25 mm (0.010) per side.

Dimension, mm		
Symbol	MIN	MAX
A	18.67	19.69
B	6.1	7.11
C		5.33
D	0.36	0.56
F	1.14	1.78
G	2.54	
H	7.62	
J	0°	10°
K	2.92	3.81
L	7.62	8.26
M	0.2	0.36
N	0.38	

**D SUFFIX SOIC  
(MS - 012AC)**



$\oplus 0.25 (0.010) \text{ (M) T (C) (M)}$

**NOTES:**

- Dimensions A and B do not include mold flash or protrusion.
- Maximum mold flash or protrusion 0.15 mm (0.006) per side for A; for B - 0.25 mm (0.010) per side.

Dimension, mm		
Symbol	MIN	MAX
A	9.8	10
B	3.8	4
C	1.35	1.75
D	0.33	0.51
F	0.4	1.27
G	1.27	
H	5.72	
J	0°	8°
K	0.1	0.25
M	0.19	0.25
P	5.8	6.2
R	0.25	0.5